

UNISONIC TECHNOLOGIES CO., LTD

1N50-SE2 Preliminary Power MOSFET

1.0A, 500V N-CHANNEL POWER MOSFET

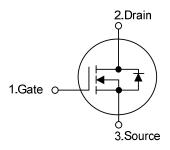
■ DESCRIPTION

The UTC **1N50-SE2** is a high voltage MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient AC to DC converters and bridge circuits.

■ FEATURES

- * $R_{DS(ON)} \le 10 \Omega$ @ $V_{GS}=10V$, $I_D=0.5A$
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

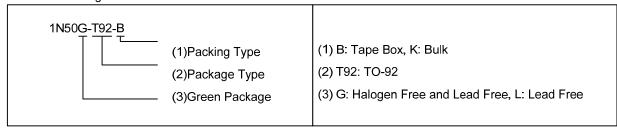
■ SYMBOL



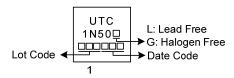
ORDERING INFORMATION

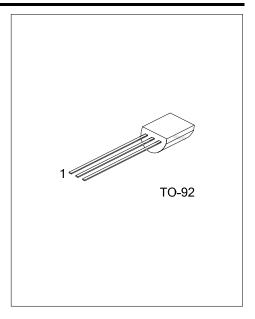
Ordering Number		Dookogo	Pin .	Assignn	Dooking		
Lead Free	Halogen Free	Package	1	2	3	Packing	
1N50L-T92-B	1N50G-T92-B	TO-92	G	D	S	Tape Box	
1N50L-T92-K	1N50G-T92-K	TO-92	G	D	S	Bulk	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING





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■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	500	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous	I _D	1.0	Α
	Pulsed (Note 2)	I _{DM}	2.0	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	21	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.4	V/ns
Power Dissipation		P_{D}	2.7	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 30mH, I_{AS} = 1.2A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 4. $I_{SD} \le 1.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	160	°C/W	
Junction to Case	θ_{JC}	125 (Note)	°C/W	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

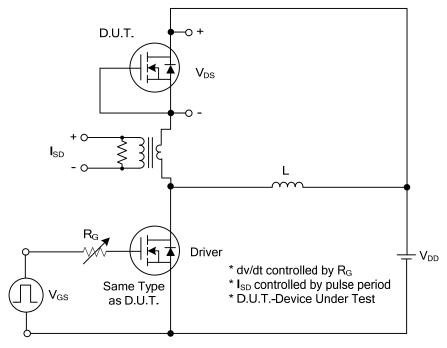
■ ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	500			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =500V, V _{GS} =0V			10	μΑ
Gate-Source Leakage Current	Forward		V _{GS} =30V, V _{DS} =0V			100	nA
	Reverse	I_{GSS}	V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V_{GS} =10V, I_D =0.5A			10	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance	nput Capacitance				80		pF
Output Capacitance		Coss	V _{DS} =25V, V _{GS} =0V, f=1MHz		11		pF
Reverse Transfer Capacitance		C_{RSS}			1		pF
SWITCHING CHARACTERISTIC	cs						
Total Gate Charge (Note 1)		Q_G	V _{DS} =400V, V _{GS} =10V, I _D =1.0A,		8		nC
Gate to Source Charge		Q_{GS}	I_{G} =1mA (Note 1, 2)		2.5		nC
Gate to Drain Charge		Q_GD	IG-IIIA (Note 1, 2)		1.2		nC
Turn-ON Delay Time (Note 1)		t _{D (ON)}			6		ns
Rise Time		t_R	V_{DD} =100V, V_{GS} =10V, I_{D} =1.0A,		15		ns
Turn-OFF Delay Time		t _{D (OFF)}	R _G =25Ω (Note 1, 2)		14		ns
Fall-Time	Fall-Time				36		ns
DRAIN-SOURCE DIODE CHAR	ACTERISTICS	AND MAXII	MUM RATINGS				
Maximum Body-Diode Continuous Current		I_S				1.0	Α
Maximum Body-Diode Pulsed Current (Note 1)		I _{SM}				2.0	Α
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =1.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time		t _{rr}	I _S =1.0A, V _{GS} =0V		115		ns
Body Diode Reverse Recovery Charge		Q_{rr}	dI _F /dt=100A/μs		0.6		μC

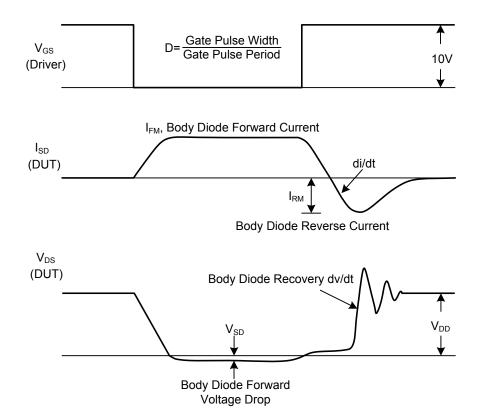
Notes: 1. Pulse Test: Pulse Width≤300µs, Duty Cycle≤2%

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

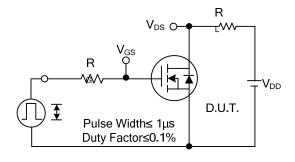


Peak Diode Recovery dv/dt Test Circuit

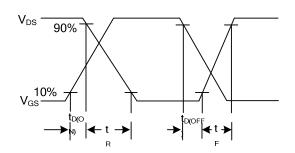


Peak Diode Recovery dv/dt Waveforms

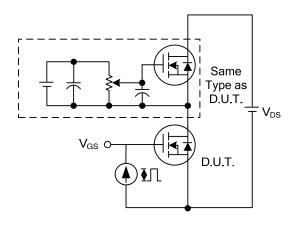
TEST CIRCUITS AND WAVEFORMS



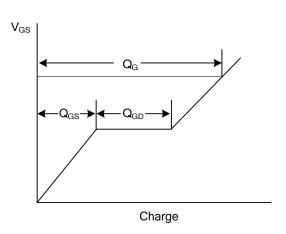
Switching Test Circuit



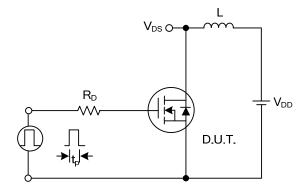
Switching Waveforms



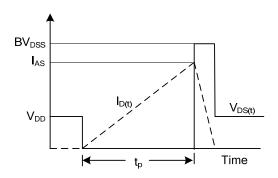
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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